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TITLE: RESISTANCE WELDING OF A FRAME AND A SUBSTRATE

ABSTRACT

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10 A method of connecting together a frame (5) and a substrate (7) and an assembly of the frame (5) and the substrate (7) are disclosed. The frame (5) is formed from a metal or an alloy and the substrate (7) is formed from a dielectric material. The substrate (7) also comprises one or more deposits (27) of a metal or an alloy. The method comprises positioning together the frame (5) and the substrate (7) so that there is contact between the frame (15) and at least one of the deposits (27) and thereafter resistance welding together the frame (5) and the substrate (7) at the region(s) of contact.

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